

## KSD5041

### **AF Output Amplifier for Electronic Flash Unit**

- Low Collector-Emitter Saturation Voltage
- High Performance at Low Supply Voltage



# **NPN Epitaxial Silicon Transistor**

## **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>CEO</sub>	Collector-Emitter Voltage	20	V
V <sub>EBO</sub>	Emitter-Base Voltage	7	V
I <sub>C</sub>	Collector Current	5	А
P <sub>C</sub>	Collector Power Dissipation	0.75	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C=1$ mA, $I_B=0$	20			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_C=10\mu A, I_C=0$	7			V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> =10V, I <sub>E</sub> =0			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB}$ =7V, $I_{C}$ =0			0.1	μΑ
h <sub>FE1</sub>	DC Current Gain	$V_{CE}$ =2V, $I_{C}$ =0.5A	180		600	
h <sub>FE2</sub>		$V_{CE}=2V$ , $I_{C}=2A$	150			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =3A, I <sub>B</sub> =0.1A			1	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =6V, I <sub>C</sub> =50mA		150		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =20V, I <sub>E</sub> =0, f=1MHz			50	pF

# **h**<sub>FE</sub> Classification

Classification	Р	Q	R
h <sub>FE</sub>	180 ~ 270	230 ~ 380	340 ~ 600

 $V_{\text{CE}}$ = 2V  $T_a$  = 25 °C

# **Typical Characteristics**

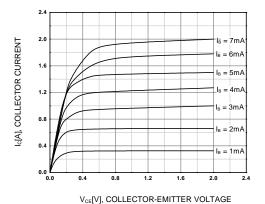


Figure 1. Static Characteristic

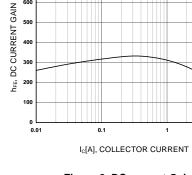


Figure 2. DC current Gain

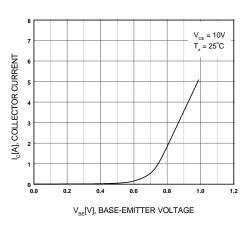


Figure 3. Base-Emitter Saturation Voltage

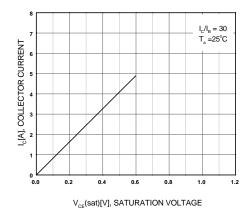


Figure 4. Collector-Emitter Saturation Voltage

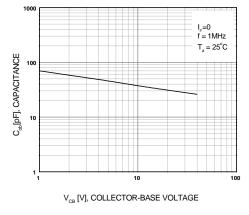


Figure 5. Collector Output Capacitance

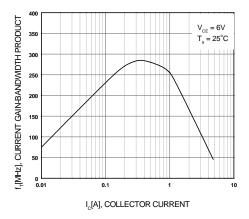


Figure 6. Current Gain Bandwidth Product

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# Typical Characteristics (Continued)

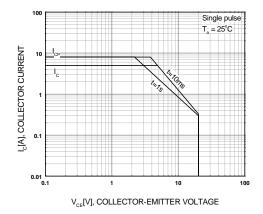


Figure 7. Safe Operating Area

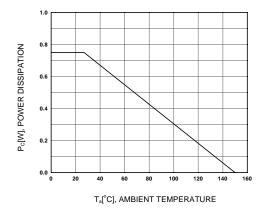
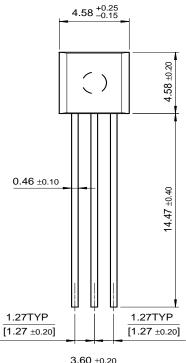
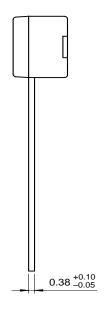


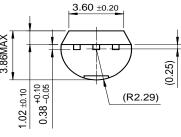
Figure 8. Power Derating

# **Package Dimensions**

TO-92







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CoolFET™	FASTr™	MicroFET™	PowerTrench <sup>®</sup>	SuperSOT™-6
$CROSSVOLT^{TM}$	FRFET™	MicroPak™	QFET™	SuperSOT™-8
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EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic™
E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™
Across the board.	Around the world.™	OCXPro™	RapidConnect™	UltraFET <sup>®</sup>
The Power Franchise™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX <sup>TM</sup>
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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